

74F00

Quad 2-Input NAND Gate

General Description

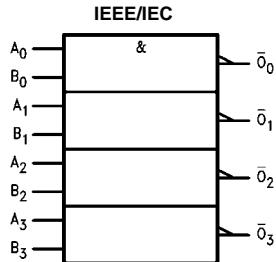
This device contains four independent gates, each of which performs the logic NAND function.

Ordering Code:

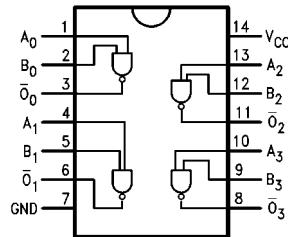
Order Number	Package Number	Package Description
74F00SC	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
74F00SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F00PC	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
A _n , B _n bar O _n	Inputs Outputs	1.0/1.0 50/33.3	20 μ A/-0.6 mA -1 mA/20 mA

Absolute Maximum Ratings(Note 1)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +150°C
V_{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA
Voltage Applied to Output	
in HIGH State (with $V_{CC} = 0V$)	
Standard Output	-0.5V to V_{CC}
3-STATE Output	-0.5V to +5.5V
Current Applied to Output	
in LOW State (Max)	twice the rated I_{OL} (mA)
ESD Last Passing Voltage (Min)	4000V

Recommended Operating Conditions

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Units	V_{CC}	Conditions
V_{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V_{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V_{CD}	Input Clamp Diode Voltage			-1.2	V	Min	$I_{IN} = -18 \text{ mA}$
V_{OH}	Output HIGH Voltage 10% V_{CC}	2.5			V	Min	$I_{OH} = -1 \text{ mA}$
	5% V_{CC}	2.7					$I_{OH} = -1 \text{ mA}$
V_{OL}	Output LOW Voltage 10% V_{CC}			0.5	V	Min	$I_{OL} = 20 \text{ mA}$
I_{IH}	Input HIGH Current			5.0	μA	Max	$V_{IN} = 2.7\text{V}$
I_{BVI}	Input HIGH Current Breakdown Test			7.0	μA	Max	$V_{IN} = 7.0\text{V}$
I_{CEX}	Output HIGH Leakage Current			50	μA	Max	$V_{OUT} = V_{CC}$
V_{ID}	Input Leakage Test	4.75			V	0.0	$I_{ID} = 1.9 \mu\text{A}$ All other pins grounded
I_{OD}	Output Leakage Circuit Current			3.75	μA	0.0	$V_{OD} = 150 \text{ mV}$ All other pins grounded
I_{IL}	Input LOW Current			-0.6	mA	Max	$V_{IN} = 0.5\text{V}$
I_{OS}	Output Short-Circuit Current	-60		-150	mA	Max	$V_{OUT} = 0\text{V}$
I_{CCH}	Power Supply Current		1.9	2.8	mA	Max	$V_O = \text{HIGH}$
I_{CCL}	Power Supply Current		6.8	10.2	mA	Max	$V_O = \text{LOW}$

AC Electrical Characteristics

Symbol	Parameter	$T_A = +25^\circ\text{C}$			$T_A = -55^\circ\text{C} \text{ to } +125^\circ\text{C}$			$T_A = 0^\circ\text{C} \text{ to } +70^\circ\text{C}$			Units
		Min	Typ	Max	Min	Max	Min	Max	Min	Max	
t_{PLH}	Propagation Delay $A_n, B_n \text{ to } \bar{O}_n$	2.4	3.7	5.0	2.0	7.0	2.4	6.0			ns
t_{PHL}		1.5	3.2	4.3	1.5	6.5	1.5	5.3			